Panasonic

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DOCUMENT COVER PAGE

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Note: This cover page establishes the Doc No., Title and current status of the anached Socularent.

Doc No.	SDSC-PSE-AN17808B	Issue Level	Rev	Eff Date
	3D3C-F3E-AN17606B	1	4	28-MAR-05
Doc Title	Product Specifications for AN17808B	Total no. of pages (excluding this page)		14

Revision History

Issue	Rev	Eff Date	S/N	Page	Change Details	Remarks
1	2	4-NOV-04	1	-	Added this cover page.	
			2	7A	Added this page for leadfree specification.	
	3	15-DEC-04	1	7	Removed this page.	
			2	7A	Amended Outer Lead Surface Process &	
					Chip Mounting Method.	
	4	28-MAR-05	1	6	Removed physical product marking indications.	
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Product Specifications AN17808B



	DOCUMENT
Structure	Silicon Monolithic Bipolar IC
Appearance	SIL-12 Pins Plastic Package (Power-type with Fin)
Application	Low Frequency Amplifier
Function	Dual 5W Audio Power Amplifier, with muting circuit and incorporating protection circuits

A	Absolute Maximum Ratings					
No.	Item	Symbol	Ratings	Unit	Note	
jerosek	Storage Temperature	Tstg	-55 ~ +150	°C	\$1	
2	Operating Ambient Temperature	Topr	-25 ~ +75	°C	1	
3	Operating Ambient Pressure	Popr	$1.013 \times 10^5 \pm 0.61 \times 10^5$	Pa		
4	Operating Constant Acceleration	Gopr	9,810	m/s²		
5	Operating Shock	Sopr	4,900	m/s²		
6	Supply Voltage	Vcc	26.0	V		
	Supply Current	Icc	4.0	A		
8	Power Dissipation	$P_{\mathbf{D}}$	37.5	W	2	

i		***	§
	Operating Supply Voltage	Vec	10.037 24.037
	Operating Supply Voltage	V CC	10.0 V ~ 24.0 V

Note 1) The temperature of all item shall be Ta = 25°C except storage temperature and operating ambient temperature.

2) Ta = 75°C

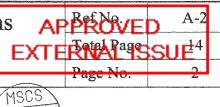
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A	Absolute Maximum Ratings					
No.	Item	Symbol	Ratings	Unit	Note	
personal distribution of the second s	Pin Voltage (2-Pin)	V2	-0.3 ~ +3.0	V	, processing,	
2	Pin Voltage (5-Pin)	V5	-0.3 ~+3.0	V	1	

Note: 1) Do not apply a current or voltage from the external to the terminals not described above. For circuit current, '+' denotes the current flowing into IC and, '-' denotes the current flowing out of IC.

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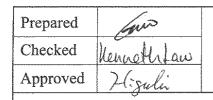
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В	Electrical Characteristi	cs (Ta= Vcc=	25°C =19V	\pm 2°C, unless otherwise , RL=8 Ω and f=1kHz)	specific	ed,			ALI-CHILATA-CLARESTON DON-
No.	Item	Symbol	Test Cir- cuit	Condition	Min	Limit Typ	Max	Unit	Note
1-00¢	Quiescent Current	Icq	1	Vin=0mV	1495	35	70	mA	
2	Output End Noise Voltage	Vno	W-massed	No Input Rg=10kΩ	del	0.22	0.4	mV	- Венева
3	Voltage Gain	Gv	1	Vin=57mV	32	34	36	dВ	
4	Total Harmonic Distortion	THD	1994	Vin=57mV	7001	0.2	0.4	%	***************************************
5	Maximum Output Power 1	Po1	quessed.	Vcc=19V THD=10%	4.0	5.0	***	W	
6	Maximum Output Power 2	Po2	percet	Vcc=22V THD=10%	5.6	7.0	A44.	W	THE STATE OF
7	Ripple Rejection Ratio	RR	promed	Vr=1Vrms, fr=120Hz, Rg=10kΩ	45	55	1004	dВ	жени полительной
8	Channel Balance	CB	henoral	Vin=57mV	-1.0	0	1.0	dB	THE CONTRACT OF THE CONTRACT O
9	Muting Ratio	MR	The state of the s	Vin=57mV Vmute ≥ 3.0V	65	75	-	dB	
10	Muting Control Voltage	Vmute	America	Vin = 57mV, MR ≥ 65dB	3.0	dia.	366	V	
prosed.	Standby On Voltage	Vstb-on	person	No Input Icc < 0.1mA	444	999	0.4	V	A CONTRACTOR OF THE PROPERTY O
12	Standby Off Voltage	Vstb-off	1	No Input Icc ≥ 17mA	3,0			V	
13	Channel Crosstalk	СТ	josenk	Vin = 57mV $Rg=10kΩ$	50	60	70	dB	

Note 1) For this measurement, use the 20Hz~20kHz (12dB/OCT) filter.

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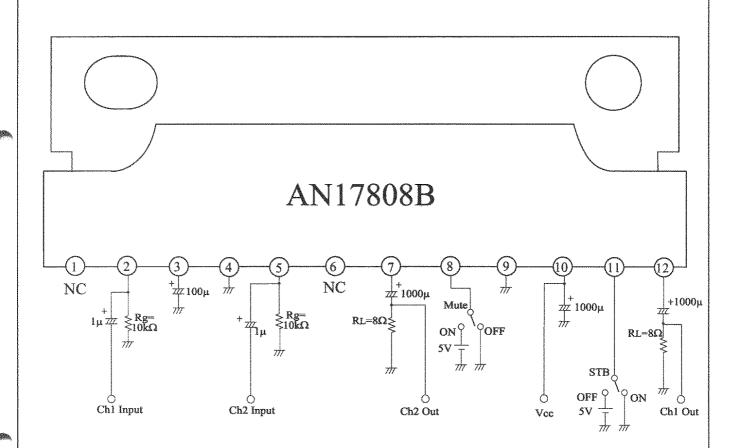


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(Description of Test Circuit and Test Method)
Test Circuit 1

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Note: For STB 'OFF', connect to 5V. Mute 'OFF' means 0V.

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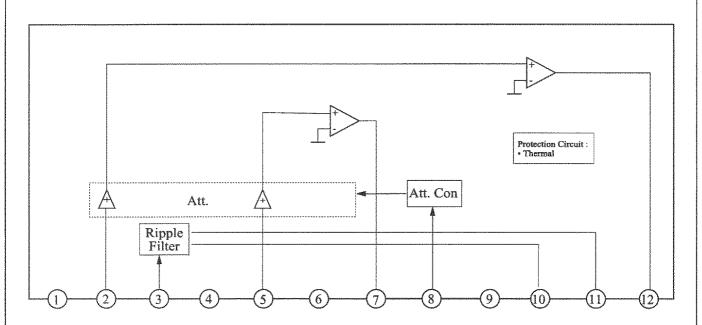
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Circuit Function Block Diagram





Pin Descriptions

Pin No.	Pin Name	Pin No.	Pin Name
1	N.C	7	Channel 2 Output
2	Channel 1 Input	8	Mute
3	Ripple Filter	9	Output GND
4	Input GND	10	Vec
5	Channel 2 Input	11	Standby
6	N.C	12	Channel 1 Output

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Product Specifications

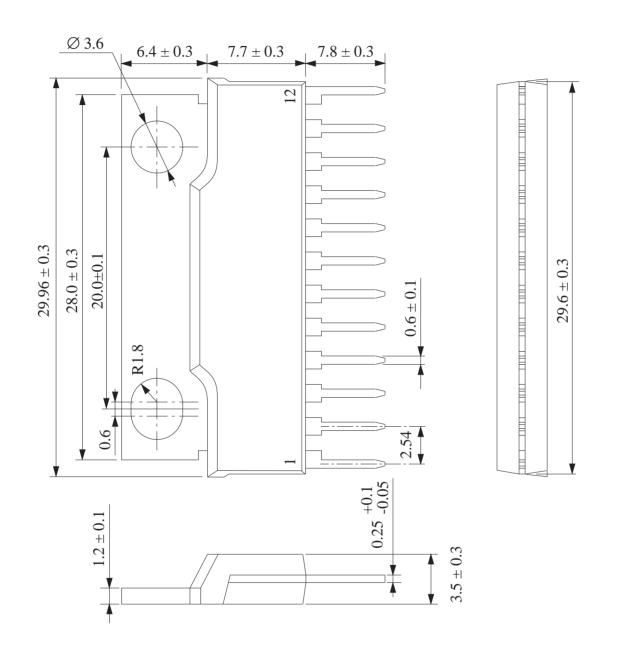
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12-SIL(FP)

Package Name FP-12S

Unit: mm

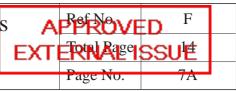


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(Structure Description)

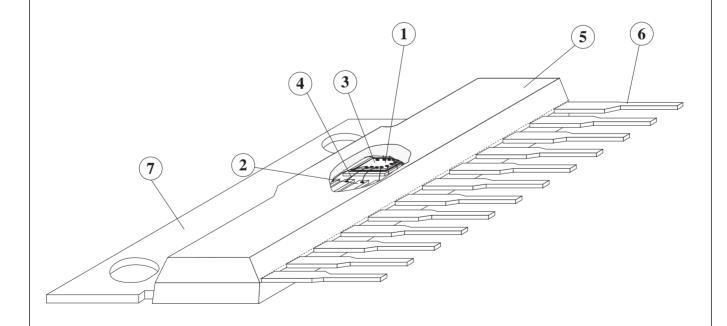
Chip surface passivation	SiN,	PSG,	Others ()	1
Lead frame material	Fe group,	Cu group,	Others ()	2,6
Inner lead surface process	(Ag plating,	Au plating,	Others ()	2
Outer lead surface process	Solder plating	(98Sn-2Bi), Solder dip,	, Others ()	6
Chip mounting method	Ag paste,	Au-Si alloy, Solder (9	5.5Pb-2.5Ag-2Sn)	**	3
Wire bonding method	Thermalsonic	bonding,	Others ()	4
Wire material	Au,		Others ()	4
Mold material	Epoxy,		Others ()	5
Molding method	Transfer mold	, Multiplunger mold,	Others ()	5
Fin material	Cu group,		Others ()	7

Package FP-12S

*3

*3

**Under RoHS exemption clause, Lead (Pb) in high melting temperature type solder (i.e. tin-lead solder alloys containing more than 85% of lead), is exempted until 2010.



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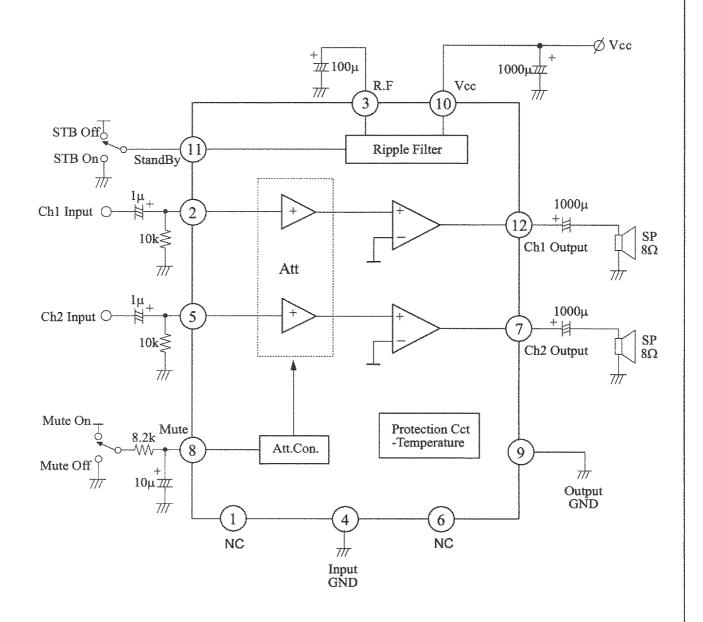
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Application Circuit 1

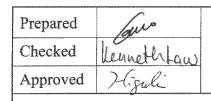
Standby Pin is controlled by microcontroller.





STB 'OFF'	5V
STB 'ON'	0V
Mute 'OFF'	0V
Mute 'ON'	5V

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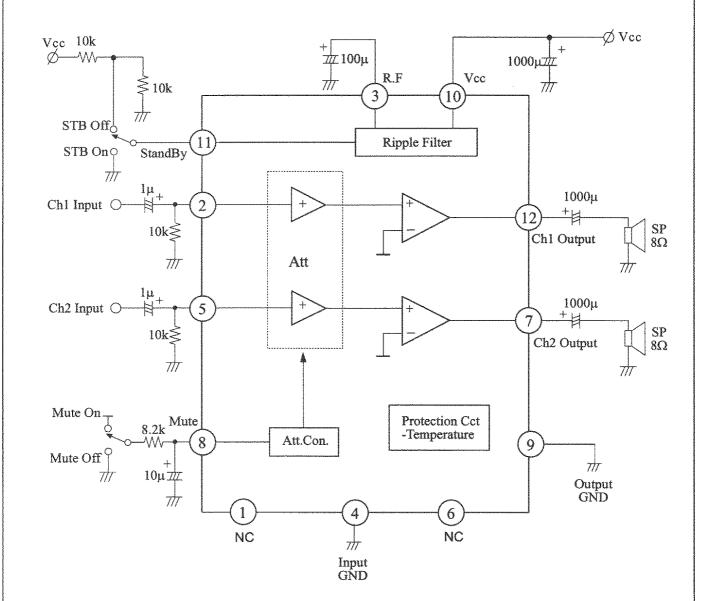
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Application Circuit 2

Standby Pin is controlled by Vcc.



Mute 'OFF'	0V
Mute 'ON'	5V

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Pin No.	Function	Adjacent Circuitry	Description	DC Bias (V)
2, 5	Ch1, Ch2 Input	5 2 200 400 30k	This is the amplifier input pin.	0V
3	Ripple Filter	30k 3 20k 15k	This is the pin to connect the positive terminal of a ripple filter capacitor.	Vcc-1.5VBE
4	Input GND		Input ground pin.	0V
1,6	Not Connected			

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CONTROL

Pin No.	Function	Adjacent Circuitry	Description	DC Bias (V)
12,	Ch1 and Ch2 Output	Pre Amp Driver Cct 7 12 600 Vcc/2	Ch1 and Ch2 output pin	Vcc/2
8	Mute	3k 3k 3k 4	Mute input pin. Mute 'On' = 5V Mute 'Off' = 0V	
9	Output GND		Ch1 and Ch2 output ground.	0V
10	Vcc		This is the power supply pin.	Typ: 19V

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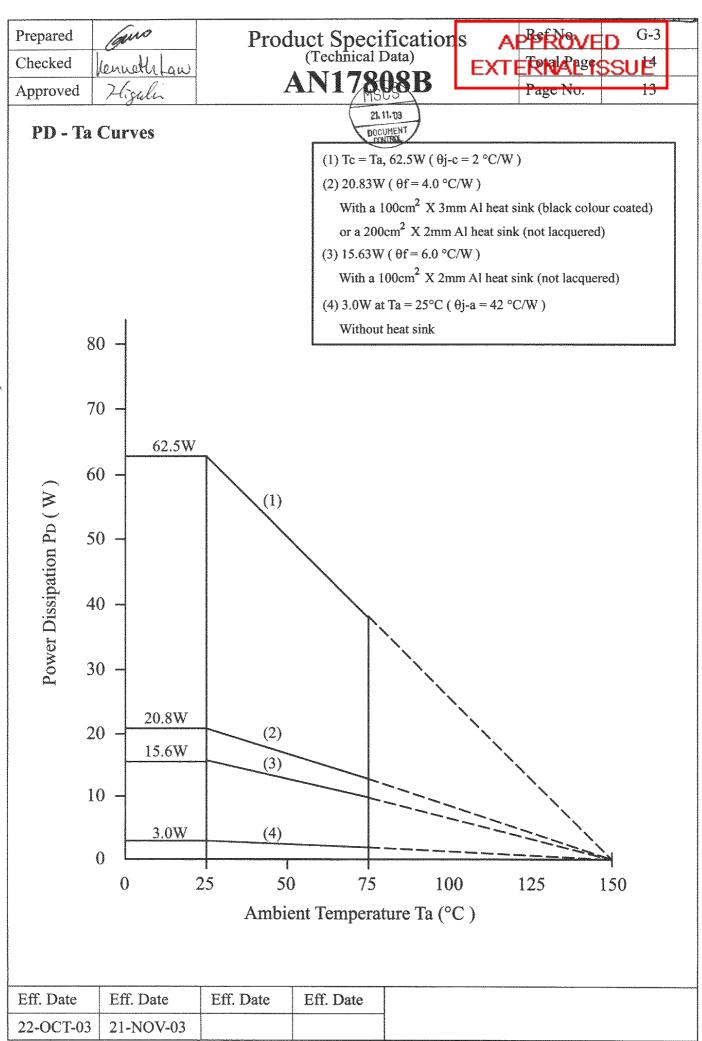
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Pin No.	Function	Adjacent Circuitry	Description	DC Bias (V)
11	Standby	10k 3k	This is the Standby control pin.	

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### **Application's Precautions**

- (1) External heatsink is needed when used. External heatsink should be fixed to the chassis.
- (2) Fin of the IC can be connected to GND.
- (3) Please prevent "Output to Vcc short", "Output to GND short", "Pin shift" and "Load short". The IC may be damaged if any of these occurs and smoke may be observed.
- (4) The temperature protection circuit will operate at Tj around 150°C. However, if temperature decrease, the protection circuit will automatically be deactivated and resume normal operation.
- (5) The Absolute Maximum Supply Voltage for this IC is specified as 26V. The IC is permitted to operate up to this voltage, without causing damage, for the condition that no signal is applied to all the 2 input pins.
- (6) For the condition of chip junction temperature below the minimum thermal shutdown temperature, under continuous operation, this will not cause damage to the IC for the recommended application. The minimum thermal shutdown temperature of this IC is typically 140 °C. This value is provided as a design reference and is not guaranteed by testing.

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